

# Presentation

# **SMT Technology**

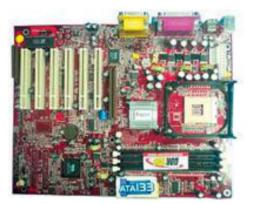


- SMC Surface Mounting Components
- SMD Surface Mounting Device
- SMT Surface Mounting Technology
- THT Through Hole Packaging Technology
- PCBPrinted Circuit Board

#### Reasons of using SMT Technology

- 1. Pursue the miniaturization of electronic products, perforation plug element previously used has been unable to reduce size
- Electronic product more complete, integrated circuit (IC) is no longer used by the perforating element, especially large-scale, highly integrated IC, we had to use surface mount components
- 3. Bulk products, production automation, factory requires high yield at low cost, producing high-quality products to meet customer demand and enhance market competitiveness
- 4. Multiple application and development of electronic components, integrated circuits (IC) development, and semiconductor materials
- Electronic technology revolution is imperative, chasing the international trend





## **Company Profile**



#### Seamark ZM Technology Group (H.K.) Co., Ltd

- Seamark ZM is a High-tec ventures of research, development, production and sales.
- ◆ Since 2005, with strong technical team, efficient management, perfect sales network, by introducing and absorbing overseas advanced technology, we constantly upgrade our existing BGA rework station four series of more than twenty varieties.
- ♦On BGA rework systems, peripheral auxiliary equipment and supplies, to win the trust and support of our customers.

















#### **Product Series**



◆ BGA/LED Rework Station ZM-R720A



**♦** Micro Focus X-Ray inspection machine X-5600



- **♦ X-Ray SMD parts counter X1000**
- ◆ TV LCD laser repair machine ZM-L80





#### **Product Presentation**



#### Optical BGA rework station for Large size PCBA



Model: ZM-R730A

- Repair component type: BGA/QFP/QFN/CSP/SOP/LED
- Power Supply:AC220V/380V ± 10%,50/60Hz, total 7500W (Max)
- PCB size: 6\*6mm-645\*520mm
- Component size: 3\*3-80\*80mm
- Temperature precision: ±1°C
- Machine movement: <u>automatically</u> heat / pick up component.
- CCD optical alignment system placing precision: 0.01MM
- Repair success rate: 99%+

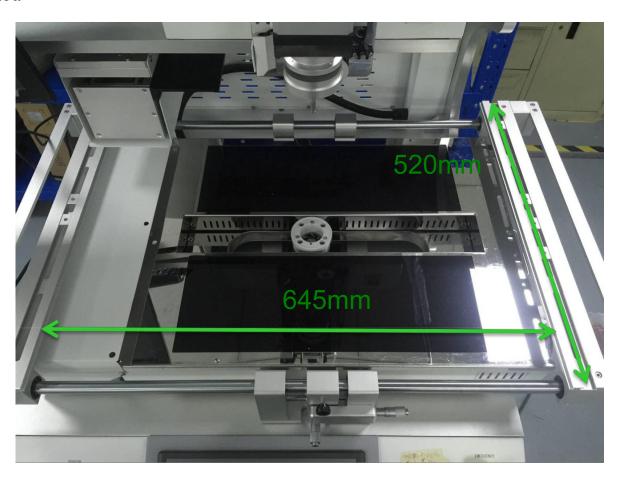


1)Three independent heating area: top hot air, bottom hot air and infrared heating. to avoid motherboards from deformation and bubble during uneven heat;



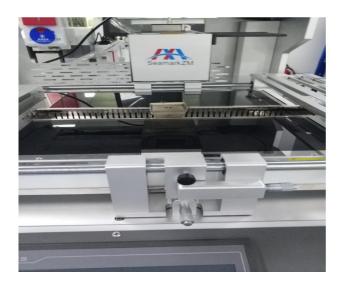


2)Large IR heating zone, specially for lage size PCBA repairing; can cover 90% of PCBA at the market.





3) IR heater adopt carbon fiber infrared tube; it can move left and right sides, which is easy for large and irregular PCBA repairing.







- 4) Bottom nozzle height adjust for any irregular boards with components on the back.
- 5) Separate Infrared heaters switches for different size of motherboards repairing which can save the cost of power.







Bottom nozzle height adjustable knob

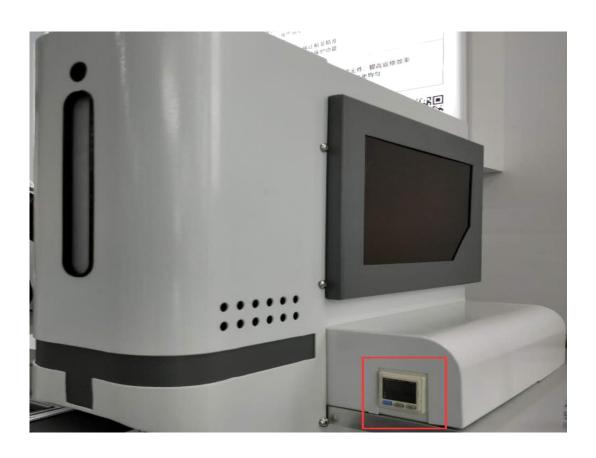


1) 10 inch high definition touch screen with <u>English and Chinese</u> operation interface, temperature and time can be freely set and modified





2) Equipped with pressure sensor for chip protection.



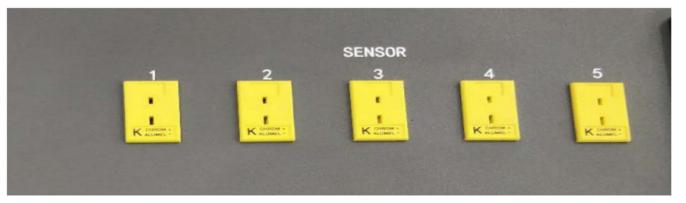


- 3) 5 external temperature sensor and 8 segments settable temperature curve for accuracy temperature control ;temperature curves can be downloaded or printed by USB2.0.
- 4) 1~100 groups temperature profile can be recorded and renamed.



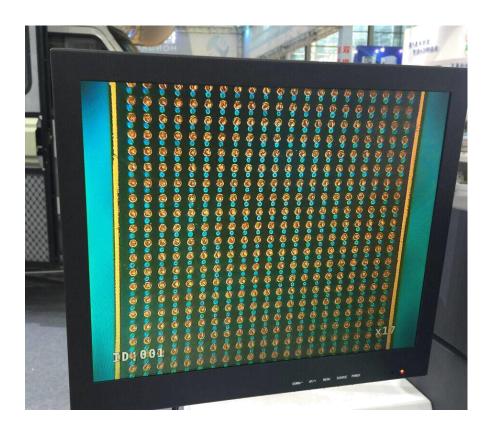






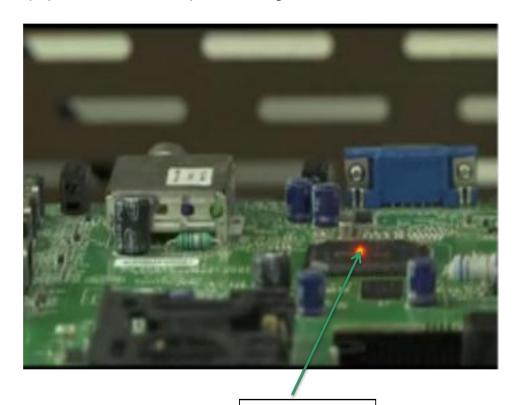


1) High-definition optical alignment system to provide clear imaging, can clearly see each alignment solder joint, to ensure alignment accuracy.





2) Laser light equiped for fast PCB posotioning.



Laser red dot

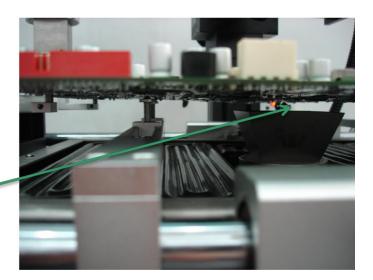


1)Use a V-groove equipped with a flexible fixture for PCB positioning; With supporting screw, to support PCB from all aspect, avoid deformation when welding.



**PCB** fixture

support screw





- 1) Automatic Feeding device.
- 2) Camera come in and out automatically.





- 1) After finishing desoldering & soldering, there is an alarming. When the temperature goes beyond control, the electric circuit can cut off automatically, with over-heating protection;
- 2) Equipped with "emergency" stop switch, meet the international safety standards.
- 3) A grounded port and "danger" stickers to avoid any potential human hazards.





# Component type availability



◆ Repair component type: BGA/QFP/QFN/CSP/SOP/LED



# Reballing Accessories

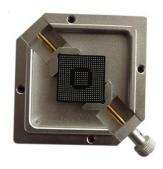


◆ Reballing kit















◆ BGA welding machine



◆ Motherboard Drying oven



#### Certificate

















#### **Honored Customer**























































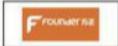
















































#### 深圳市卓茂科技有限公司

Seamark ZM Technology Group (H.K.) Co.,Ltd

# Thank you